IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

POWER OF ATTORNEY BY ASSIGNEE WITH STATEMENT UNDER 37 C.F.R. 3.73(b) AND REVOCATION OF PREVIOUS POWERS

Sir:

As the assignee of record of the entire right, title and interest of the below-identified patent applications by virtue of assignment from inventor(s) to assignee, all powers of attorney previously given are hereby revoked and the attorneys associated with:

Customer No.: 30256

are hereby appointed to prosecute and transact all business in the U.S. Patent and Trademark Office connected therewith.

Patent Applications

U.S. PATENT	FILING	TITLE	INIVERSITOD (C)	A CCLCA D AFA IT
			INVENTOR(S)	ASSIGNMENT
APPLICATION	DATE			RECORDED FROM .
NO.				INVENTOR(S) TO
				ASSIGNEE UNITED
				MICROELECTRONICS,
				INC. AT REEL/FRAME
10/954,735	9/30/2004	Cmos Silicon-Control-	Shiao-Shien	018157/0319
		Rectifier (Scr) Structure For	CHEN et al.	
		Electrostatic Discharge (Esd)		
00/624 221	7/24/2000	Protection		
09/624,321	7/24/2000	Method And Structure For	Bing-Chang	010961/0923
		Reducing Capacitance	WU	
09/847,111	5/2/2001	Between Interconnect Lines		
09/847,111	3/2/2001	Measuring System Of A Gas Stream Environment	Ya-Chuan	011779/0598
10/107.000	0.10 5.10 0.00		CHENG	
10/105,339	3/26/2002	Method Of Reducing The	Yen-Wu HSIEH	012731/0632
		Chamber Particle Level		
10/986,840	11/15/2004	Method And Structure To	Wen-Fang LEE	014502/0557
1		Improve The Gate Coupling	et al.	
		Ratio (Gcr) For		
		Manufacturing A Flash		
10/025 (20		Memory Device		
10/837,638	5/4/2004	Mask Device For	Benjamin Szu-	015299/0453
		Photolithography And	Min LIN	
		Application Thereof		

10/843,444	5/12/2004	Method Of Cleaning A Semiconductor Substrate And Cleaning Recipes	Ya-Lun CHENG et al.	015322/0921
10/784,186	2/24/2004	Method For Gap Filling	-	015024/0770
		Between Metal-Metal Lines	et al.	

I am empowered to act on behalf of the corporation identified below.

Respectfully submitted,

United Microelectronics, Inc.

Date: 2006/10/18

By: Joey Lai

Manager of IP Department United Microelectronics, Inc.